BLF174XR; **BLF174XRS**

Power LDMOS transistor

AMPLEON

Rev. 2 — 1 September 2015

Product data sheet

1. Product profile

1.1 General description

A 600 W extremely rugged LDMOS power transistor for broadcast and industrial applications in the HF to 128 MHz band.

Table 1. Application information

Test signal	f	V _{DS}	PL	Gp	η _D
	(MHz)	(V)	(W)	(dB)	(%)
CW	108	50	600	28.5	74
pulsed RF	108	50	600	29	73

1.2 Features and benefits

- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (HF to 128 MHz)
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

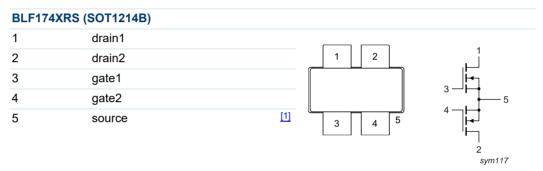
1.3 Applications

- Industrial, scientific and medical applications
- Broadcast transmitter applications

2. Pinning information

Table 2. Pinning

Pin Description Simplified outline Graphic symbol BLF174XR (SOT1214A) 1 drain1 2 drain2 3 gate1 4 gate2 5 source [1]		3		
1 drain1 2 drain2 3 gate1 4 gate2 5 source [1]	Pin	Description	Simplified outline	Graphic symbol
2 drain2 3 gate1 4 gate2 5 source [1]	BLF174XR (SOT1214A)		
2 drain2 3 gate1 4 gate2 5 source [1]	1	drain1		
4 gate2 5 source [1]	2	drain2	1 2	1
4 gate2 5 source [1]	3	gate1		, H
5 source [1]	4	gate2	3 4	5
-	5	source	[1]	4
-				' <u></u>
				_



^[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Packa	Package Package	
	Name	Description	Version
BLF174XR	-	flanged ceramic package; 2 mounting holes; 4 leads	SOT1214A
BLF174XRS	-	earless flanged ceramic package; 4 leads	SOT1214B

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	110	V
V_{GS}	gate-source voltage		-6	+11	V
T _{stg}	storage temperature		–65	+150	°C
Tj	junction temperature		<u>[1]</u> _	225	°C

^[1] Continuous use at maximum temperature will affect the reliability, for details refer to the on-line MTF calculator

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-c)}	thermal resistance from junction to case	T _j = 150 °C	[1][2] 0.18	K/W

^[1] T_i is the junction temperature.

6. Characteristics

Table 6. DC characteristics

 $T_i = 25$ °C; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 2.75 \text{ mA}$	110	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	V_{DS} = 10 V; I_{D} = 275 mA	1.25	1.7	2.25	V
I_{DSS}	drain leakage current	V_{GS} = 0 V; V_{DS} = 50 V	-	-	1.4	μΑ
I _{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	-	38	-	Α
I _{GSS}	gate leakage current	V_{GS} = 11 V; V_{DS} = 0 V	-	-	140	nA
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 9.625 \text{ A}$	-	0.15	-	Ω

Table 7. AC characteristics

 $T_i = 25$ °C; per section unless otherwise specified.

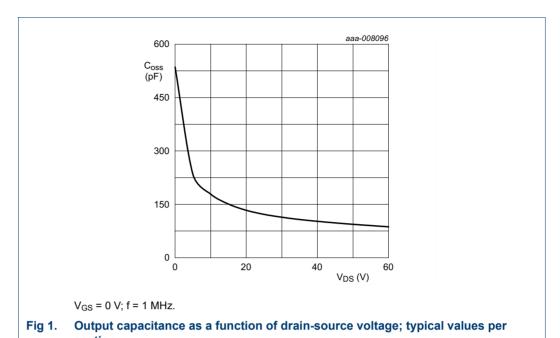
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C_{rs}	feedback capacitance	V_{GS} = 0 V; V_{DS} = 50 V; f = 1 MHz	-	2.4	-	pF
C_{iss}	input capacitance	V_{GS} = 0 V; V_{DS} = 50 V; f = 1 MHz	-	210	-	pF
C _{oss}	output capacitance	V_{GS} = 0 V; V_{DS} = 50 V; f = 1 MHz	-	94	-	pF

Table 8. RF characteristics

Test signal: CW; f = 108 MHz; RF performance at $V_{DS} = 50$ V; $I_{Dq} = 100$ mA; $T_{case} = 25$ °C; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
G_p	power gain	$P_{L} = 600 \text{ W}$	27.0	28.5	-	dB
RL_{in}	input return loss	$P_{L} = 600 \text{ W}$	-	-21	-13	dB
η_{D}	drain efficiency	P _L = 600 W	70	74	-	%

^[2] $R_{th(j-c)}$ is measured under RF conditions.



section

7. Test information

7.1 Ruggedness in class-AB operation

The BLF174XR and BLF174XRS are capable of withstanding a load mismatch corresponding to VSWR > 65 : 1 through all phases under the following conditions: $V_{DS} = 50 \text{ V}$; $I_{Dq} = 100 \text{ mA}$; $P_L = 600 \text{ W}$ pulsed; f = 108 MHz.

7.2 Impedance information

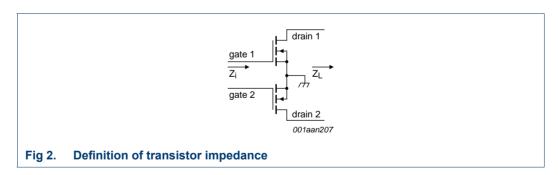


Table 9. Typical push-pull impedance

Simulated Z_i and Z_L device impedance; impedance info at $V_{DS} = 50 \text{ V}$ and $P_L = 600 \text{ W}$.

f	Z_i	Z_L
(MHz)	(Ω)	(Ω)
108	4.66 – j12.04	6.47 + j1.16

7.3 Test circuit

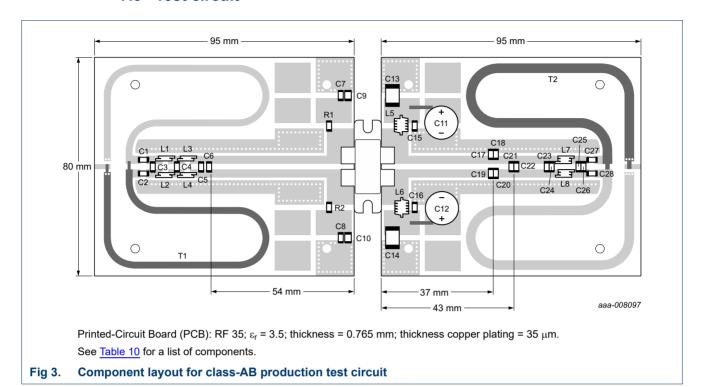


Table 10. List of components

For test circuit see Figure 3.

Component	Description	Value	Remarks
C1, C2	multilayer ceramic chip capacitor	910 pF	[1]
C3	multilayer ceramic chip capacitor	51 pF	[2]
C4	multilayer ceramic chip capacitor	43 pF	[1]
C5	multilayer ceramic chip capacitor	100 pF	[1]
C6	multilayer ceramic chip capacitor	75 pF	[1]
C7, C8, C15, C16	multilayer ceramic chip capacitor	820 pF	[1]
C9, C10	multilayer ceramic chip capacitor	4.7 μF, 100 V	TDK C5750X7R2A475KT
C11, C12	electrolytic capacitor	470 μF, 63 V	
C13, C14	multilayer ceramic chip capacitor	$4.7~\mu F$, $100~V$	
C17, C18, C19, C20	multilayer ceramic chip capacitor	39 pF	[1]
C21, C23	multilayer ceramic chip capacitor	22 pF	[1]
C22	multilayer ceramic chip capacitor	15 pF	[1]
C24	multilayer ceramic chip capacitor	20 pF	[1]
C25, C26	multilayer ceramic chip capacitor	27 pF	[1]
C27, C28	multilayer ceramic chip capacitor	1 nF	[2]
L1, L2, L3, L4	1.5 turn 0.8 mm copper wire	D = 3.6 mm, length = 1.8 mm	

Table 10. List of components ...continued For test circuit see Figure 3.

Component	Description	Value	Remarks
L5, L6	5.5 turn 0.8 mm copper wire	D = 4.4 mm, length = 5.2 mm	
L7, L8	1.5 turn 1.5 mm copper wire	D = 6.5 mm, length = 3.2 mm	
R1, R2	resistor	10.0 Ω	SMD 1206
T1	semi rigid coax	25 $Ω$, 160 mm	Micro-Coax UT-090C-25
T2	semi rigid coax	25 $Ω$, 160 mm	Micro-Coax UT-141C-25

- [1] American Technical Ceramics type 800B or capacitor of same quality.
- [2] American Technical Ceramics type 100B or capacitor of same quality.

7.4 Graphical data

The following figures are measured in a class-AB production test circuit.

7.4.1 1-Tone CW

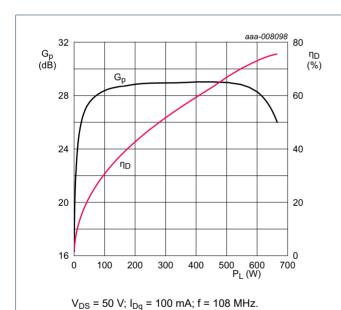
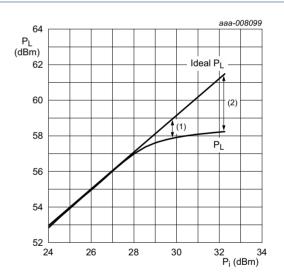


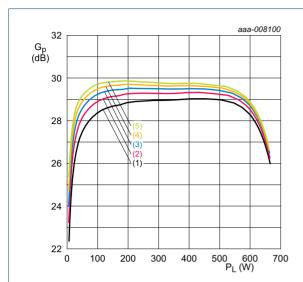
Fig 4. Power gain and drain efficiency as function of output power; typical values



 $V_{DS} = 50 \text{ V}; I_{Dq} = 100 \text{ mA}; f = 108 \text{ MHz}.$

- (1) $P_{L(1dB)} = 57.9 \text{ dBm } (613 \text{ W})$
- (2) $P_{L(3dB)} = 58.2 \text{ dBm } (665 \text{ W})$

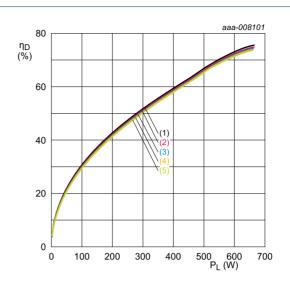
Fig 5. Output power as a function of input power; typical values



 $V_{DS} = 50 \text{ V}$; f = 108 MHz.

- (1) $I_{Dq} = 100 \text{ mA}$
- (2) $I_{Dq} = 200 \text{ mA}$
- (3) $I_{Dq} = 300 \text{ mA}$
- (4) $I_{Dq} = 400 \text{ mA}$
- (5) $I_{Dq} = 500 \text{ mA}$

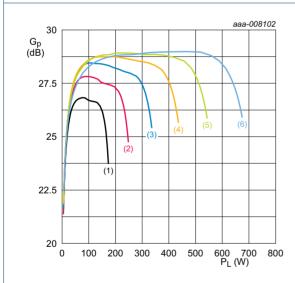
Fig 6. Power gain as a function of output power; typical values



 $V_{DS} = 50 \text{ V}; f = 108 \text{ MHz}.$

- (1) $I_{Dq} = 100 \text{ mA}$
- (2) $I_{Dq} = 200 \text{ mA}$
- (3) $I_{Dq} = 300 \text{ mA}$
- (4) $I_{Dq} = 400 \text{ mA}$
- (5) $I_{Dq} = 500 \text{ mA}$

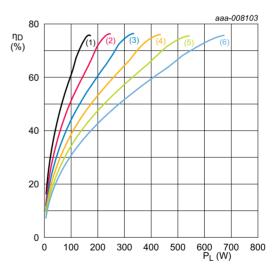
Fig 7. Drain efficiency as a function of output power; typical values



 $I_{Dq} = 100 \text{ mA}$; f = 108 MHz.

- (1) $V_{DS} = 25 \text{ V}$
- (2) $V_{DS} = 30 \text{ V}$
- (3) $V_{DS} = 35 V$
- (4) $V_{DS} = 40 \text{ V}$
- (5) $V_{DS} = 45 \text{ V}$
- (6) $V_{DS} = 50 \text{ V}$

Fig 8. Power gain as a function of output power; typical values



 $I_{Dq} = 100 \text{ mA}$; f = 108 MHz.

- (1) $V_{DS} = 25 V$
- (2) $V_{DS} = 30 \text{ V}$
- (3) $V_{DS} = 35 V$
- (4) $V_{DS} = 40 \text{ V}$
- (5) $V_{DS} = 45 V$
- (6) $V_{DS} = 50 \text{ V}$

Fig 9. Drain efficiency as a function of output power; typical values

8. Package outline

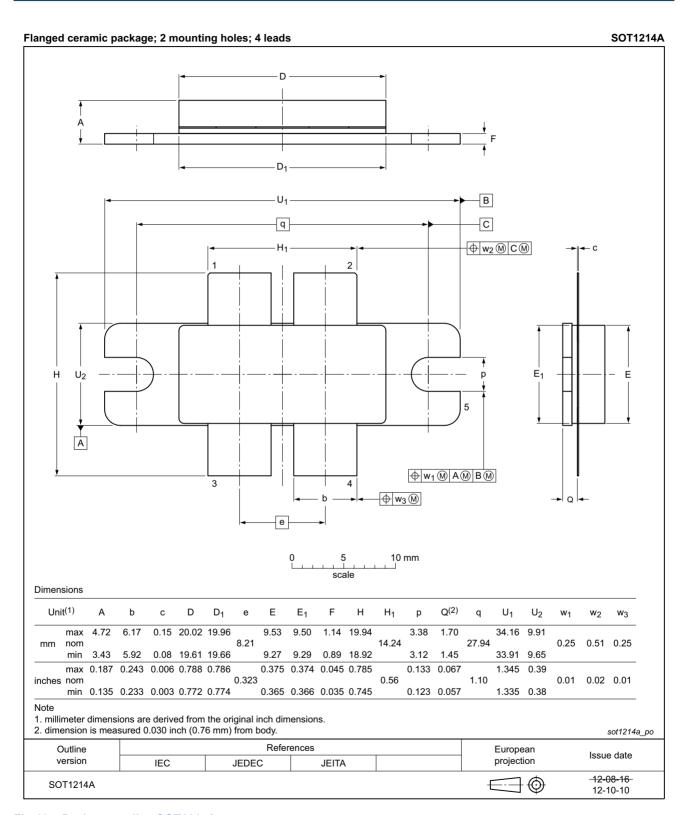


Fig 10. Package outline SOT1214A

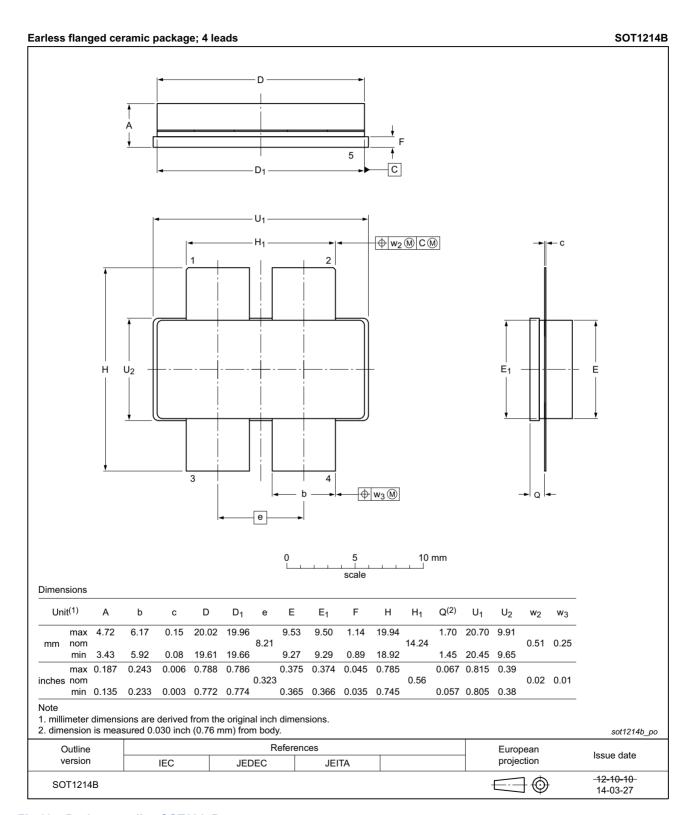


Fig 11. Package outline SOT1214B

9. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

10. Abbreviations

Table 11. Abbreviations

10010 111 710	2.01.4.10.10
Acronym	Description
CW	Continuous Wave
ESD	ElectroStatic Discharge
HF	High Frequency
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
MTF	Median Time to Failure
SMD	Surface Mounted Device
VSWR	Voltage Standing-Wave Ratio
XR	eXtremely Rugged

11. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
BLF174XR_BLF174XRS#2	20150901	Product data sheet	-	BLF174XR_BLF174X RS v.1		
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of Ampleon. Legal texts have been adapted to the new company name where appropriate. 					
BLF174XR_BLF174XRS v.1	20130625	Product data sheet	-	-		

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